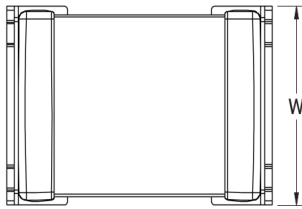


TOP VIEW
Single or Double Chip Stack



PROFILE VIEW
Single Chip Stack



Click [here](#) for the 3D model.

Dimensions

L	5mm +/-0.5mm
W	3.5mm +/-0.5mm
T	2.65mm +/-0.35mm
B	1.1mm +/-0.3mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

General Information

Series	KPS SMD Comm X7R
Style	Stacked Chip
Description	SMD, MLCC, Stacked, Single Chip, Temperature Stable
Features	Temperature Stable
RoHS	Yes
Termination	Tin
AEC-Q200	No
Component Weight	170 mg
Chip Size	1812-1
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.47 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	2.1277 GOhms